# General Purpose Transistor NPN Silicon

### Features

- Moisture Sensitivity Level: 1
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	75	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	600	mAdc
Electrostatic Discharge	ESD	HBM Class 2 MM Class B	

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1), T <sub>A</sub> = 25°C	P <sub>D</sub>	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

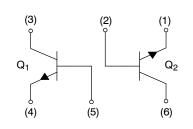
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



# **ON Semiconductor®**

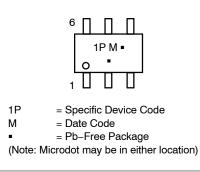
http://onsemi.com





SC-88/SC70-6/SOT-363 CASE 419B STYLE 1

## MARKING DIAGRAM



## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBT2222ADW1T1G	SOT-363 (Pb-Free)	3000 / Tape & Reel
NSVBT2222ADW1T1G	SOT–363 (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Charact	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS		•			•
Collector-Emitter Breakdown Voltage	$(I_{\rm C} = 10 \text{ mAdc}, I_{\rm B} = 0)$	V <sub>(BR)CEO</sub>	40	-	Vdc
Collector-Base Breakdown Voltage	$(I_{C} = 10 \ \mu Adc, I_{E} = 0)$	V <sub>(BR)CBO</sub>	75	-	Vdc
Emitter-Base Breakdown Voltage,	$(I_E = 10 \ \mu Adc, \ I_C = 0)$	V <sub>(BR)EBO</sub>	6.0	-	Vdc
Collector Cutoff Current	$(V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 3.0 \text{ Vdc})$	I <sub>CEX</sub>	-	10	nAdc
Collector Cutoff Current	$(V_{CB} = 60 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 60 \text{ Vdc}, I_E = 0, T_A = 125^{\circ}\text{C})$	I <sub>СВО</sub>		0.01 10	μAdc
Emitter Cutoff Current	$(V_{EB} = 3.0 \text{ Vdc}, I_{C} = 0)$	I <sub>EBO</sub>	-	100	nAdc
Base Cutoff Current	$(V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 3.0 \text{ Vdc})$	I <sub>BL</sub>	-	20	nAdc
ON CHARACTERISTICS					•
DC Current Gain		h <sub>FE</sub>	05		-

Be carron clain		''FE			
	(I <sub>C</sub> = 0.1 mAdc, V <sub>CE</sub> = 10 Vdc)	_	35	-	
	(I <sub>C</sub> = 1.0 mAdc, V <sub>CE</sub> = 10 Vdc)		50	-	
	(I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 10 Vdc)		75	-	
(I <sub>C</sub> = 1	0 mAdc, V <sub>CE</sub> = 10 Vdc, T <sub>A</sub> = -55°C)		35	-	
	= 150 mAdc, V <sub>CE</sub> = 10 Vdc) (Note 2)		100	300	
(I <sub>C</sub> =	= 150 mAdc, V <sub>CE</sub> = 1.0 Vdc) (Note 2)		50	-	
(I <sub>C</sub> :	= 500 mAdc, V <sub>CE</sub> = 10 Vdc) (Note 2)		40	-	
Collector-Emitter Saturation Voltage (Note 2)		V <sub>CE(sat)</sub>			Vdc
5 ( )	(I <sub>C</sub> = 150 mAdc, I <sub>B</sub> = 15 mAdc)	OE(Sul)	-	0.3	
	$(I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$		-	1.0	
Read Emitter Seturation Voltage (Note 2)		M			Vdc
Base – Emitter Saturation Voltage (Note 2)	(I <sub>C</sub> = 150 mAdc, I <sub>B</sub> = 15 mAdc)	V <sub>BE(sat)</sub>	0.6	1.2	vuc
	$(I_{\rm C} = 500 \text{ mAdc}, I_{\rm B} = 50 \text{ mAdc})$ $(I_{\rm C} = 500 \text{ mAdc}, I_{\rm B} = 50 \text{ mAdc})$		0.0	2.0	
	$(I_{\rm C} = 500 \text{mAdc}, I_{\rm B} = 50 \text{mAdc})$		_	2.0	

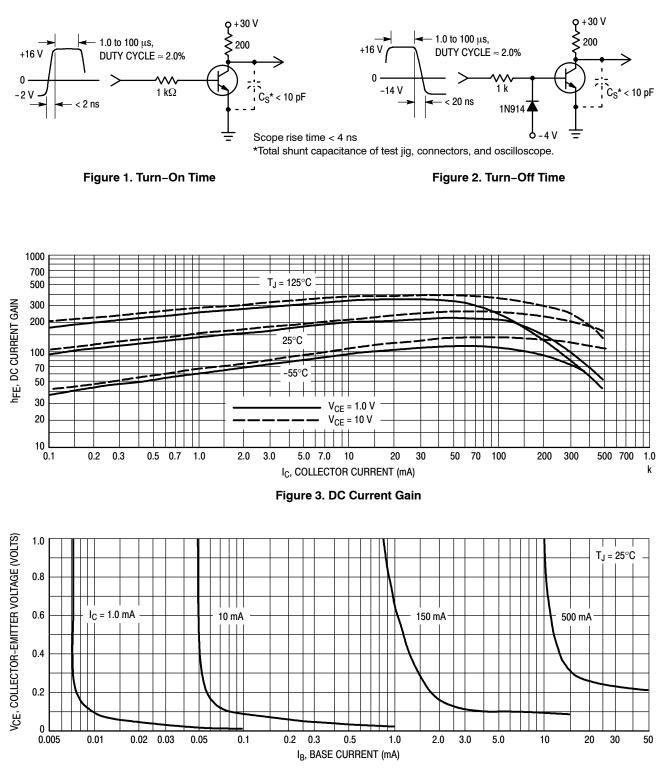
#### SMALL-SIGNAL CHARACTERISTICS

Current-Gain - Bandwidth Pro	f <sub>T</sub>	300	-	MHz	
	(I <sub>C</sub> = 20 mAdc, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)				
Output Capacitance	(V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>obo</sub>	-	8.0	pF
Input Capacitance	$(V_{EB} = 0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz})$	C <sub>ibo</sub>	-	25	pF
Input Impedance	$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$ $(I_{C} = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h <sub>ie</sub>	2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio	$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$ $(I_{C} = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h <sub>re</sub>		8.0 4.0	X 10 <sup>-4</sup>
Small-Signal Current Gain	$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$ $(I_{C} = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h <sub>fe</sub>	50 75	300 375	_
Output Admittance	$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$ $(I_{C} = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h <sub>oe</sub>	5.0 25	35 200	μmhos
Collector Base Time Constant	$(I_E = 20 \text{ mAdc}, V_{CB} = 20 \text{ Vdc}, f = 31.8 \text{ MHz})$	rb, C <sub>c</sub>	-	150	ps
Noise Figure	$I_C$ = 100 $\mu$ Adc, V <sub>CE</sub> = 10 Vdc, R <sub>S</sub> = 1.0 kΩ, f = 1.0 kHz)	NF	-	4.0	dB
SWITCHING CHARACTERIS	rics		•		•

Delay Time	(V <sub>CC</sub> = 30 Vdc, V <sub>BE(off)</sub> = -0.5 Vdc,	t <sub>d</sub>	-	10	20
Rise Time	$I_{\rm C} = 150 \text{ mAdc}, I_{\rm B1} = 15 \text{ mAdc})$	t <sub>r</sub>	-	25	ns
Storage Time	(V <sub>CC</sub> = 30 Vdc, I <sub>C</sub> = 150 mAdc,	ts	-	225	
Fall Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$	t <sub>f</sub>	-	60	ns

2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%. 3. f<sub>T</sub> is defined as the frequency at which |h<sub>fe</sub>| extrapolates to unity.

## SWITCHING TIME EQUIVALENT TEST CIRCUITS





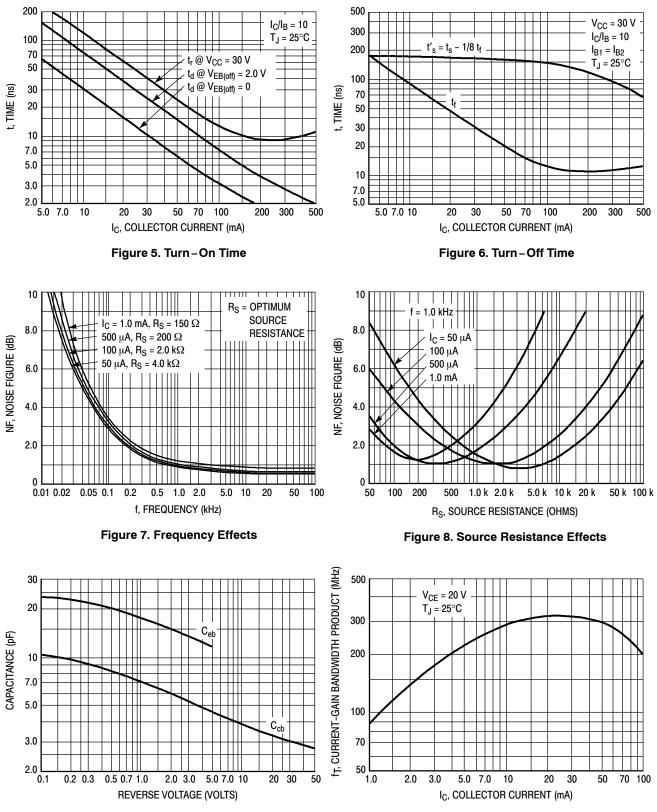


Figure 9. Capacitances

Figure 10. Current–Gain Bandwidth Product

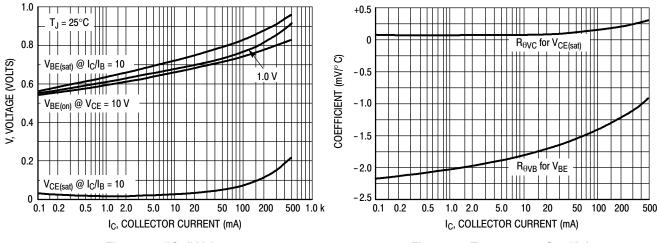
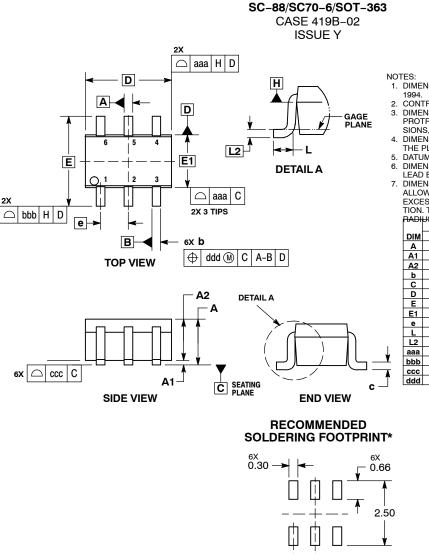


Figure 11. "On" Voltages

Figure 12. Temperature Coefficients

#### PACKAGE DIMENSIONS



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,
- 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS MOLD FLASH, PROTRU-SIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
- DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
- THE PLASTIC BOOT AND DATOWINE. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION.
- ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER BADIUS OF THE FOOT

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α			1.10			0.043	
A1	0.00		0.10	0.000		0.004	
A2	0.70	0.90	1.00	0.027	0.035	0.039	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.08	0.15	0.22	0.003	0.006	0.009	
D	1.80	2.00	2.20	0.070	0.078	0.086	
Е	2.00	2.10	2.20	0.078	0.082	0.086	
E1	1.15	1.25	1.35	0.045	0.049	0.053	
е	0.65 BSC			0	.026 BS	С	
L	0.26	0.36	0.46	0.010	0.014	0.018	
L2	0.15 BSC			0.006 BSC			
aaa		0.15			0.006		
bbb		0.30 0.012					
CCC		0.10	_	0.004			
ddd		0.10	-	0.004			

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1

4. EMITTER 1 5. BASE 1

COLLECTOR 2

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS

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